Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	((heat adj (sink spreader) near8 (purg\$3 clean\$3)) same (inert near2 gas)) and @ad<"20040331"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/02 14:42
L2	1	((heat adj (sink spreader plate) near8 (purg\$3 clean\$3)) same (inert near2 gas)) and @ad<"20040331"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/02 14:43
L3	12	((heat adj (sink spreader plate) near8 (purg\$3 clean\$3 remov\$3)) same (inert near2 gas)) and @ad<"20040331"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/02 14:45
L4	22	((heat adj (sink spreader plate) same (purg\$3 clean\$3)) same (inert near2 gas)) and @ad<"20040331"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/02 15:07
L5	1264	(heat adj (sink spreader plate) same (purg\$3 clean\$3)) and @ad<"20040331"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/02 15:08
L6	304	(heat adj (sink spreader plate) near8 (purg\$3 clean\$3)) and @ad<"20040331"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/02 15:09
L7	75	6 and (inert n2 o2 he ne helium neon ar argon)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/02 15:09
L8	12	((heat adj (sink spreader plate) near8 (purg\$3 clean\$3)) same (inert ne o2 he ne helium neon ar argon)) and @ad<"20040331"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2005/06/02 15:18
L9	5594	(((chamber vessel) near8 (clean\$3 purg\$3)) same metal\$4) and @ad<"20040331"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/02 15:19
L10	1663	(((chamber vessel) near8 (clean\$3 purg\$3)) near8 metal\$4) and @ad<"20040331"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/02 15:26

L11	27	10 and (heat adj (sink spreader))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/02 15:38
L12	2	("20030129826").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/02 15:39
L13	1	12 and (carrier adj gas)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/02 15:39
S1	14	(("6656770") or ("5773362") or ("4607277") or ("5276289") or ("20020180035") or ("5609889") or ("6462405")).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/02 14:36
S2	1055	(264/272.17).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/28 12:19
S3	956	S2 and @ad<"20040331"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2005/05/28 12:20
S4	832	S3 and (semiconductor die dice ic (integrated adj circuit))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/28 12:20
S5	87	S4 and (heat adj (sink spreader))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/28 12:27
S6		S5 and (mold near3 gate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/28 12:21
S7	87	S4 and (heat adj (sink spreader))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/28 12:51

S8	6138	((438/122) or (438/108) or (257/712) or (257/778)).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/28 12:52
S9	5737	S8 and @ad<"20040331"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/28 12:54
S10	4	S9 and (heat adj (sink spreader) near3 gate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/28 13:07
S11	2	("6617682").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/28 15:52
S12	19	(thermal adj enhancement).ti.	IBM_TDB	OR	ON	2005/05/31 15:25
S13	1	(bellows adj heat adj sink).ti.	IBM_TDB	OR	ON	2005/05/28 16:18
S14	1	(liquid adj metal adj heat adj transfer).ti.	IBM_TDB	OR	ON	2005/05/28 16:22
S15	1	(conformable adj alloy).ti.	IBM_TDB	OR	ON	2005/05/28 16:27
S16	1	(thermal adj sponge).ti.	IBM_TDB	OR	ON	2005/05/28 16:32
S17	2	(molten adj metal).ti.	IBM_TDB	OR	ON	2005/05/28 16:33
S18	3	(molten adj solder).ti.	IBM_TDB	OR	ON	2005/05/28 16:34
S19	162	(heat adj sink).ti.	IBM_TDB	OR	ON	2005/05/28 16:34
S20	1	S19 and solder.ti.	IBM_TDB	OR	ON	2005/05/28 16:35
S21	40	S19 and solder	IBM_TDB	OR	ON	2005/05/28 17:01
S22	1	(bellows adj heat adj sink).ti.	IBM_TDB	OR	ON	2005/05/31 15:27
S23	14	(("6656770") or ("5773362") or ("4607277") or ("5276289") or ("20020180035") or ("5609889") or ("6462405")).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/28 17:18
S24	19	(thermal adj enhancement).ti.	IBM_TDB	OR	ON	2005/05/31 15:25
S25	1	(bellows adj heat adj sink).ti.	IBM_TDB	OR	ON	2005/05/31 16:01
S26	0	"09978983".ap.	IBM_TDB	OR	ON	2005/05/31 16:01
S27	0	"978983".ap.	IBM_TDB	OR	ON	2005/05/31 16:01
S28	0	09/978983.ap.	IBM_TDB	OR	ON	2005/05/31 16:03

S29	2	("6831301").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/31 16:07
S30	1	("6902956").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/31 16:09
S31	2	("20020058358").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/31 16:09